

ROHS COMPLIANT

HALOGEN

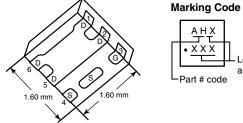
FREE

**Vishay Siliconix** 

## N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY									
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)						
	0.042 at V <sub>GS</sub> = 4.5 V	9							
30	0.046 at V <sub>GS</sub> = 2.5 V	9	5.7 nC						
	0.052 at V <sub>GS</sub> = 1.8 V	9							

#### PowerPAK SC-75-6L-Single



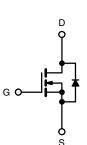
\_ot Traceability and Date code

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- DC/DC Converters
- **Boost Converters**



N-Channel MOSFET

Ordering Information:

SiB410DK-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	30			
Gate-Source Voltage		V <sub>GS</sub>	± 8	V		
	T <sub>C</sub> = 25 °C		9 <sup>a</sup>			
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C		9 <sup>a</sup>			
Continuous Diam Current $(1) = 150^{\circ}$ C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	5.9 <sup>b, c</sup>			
	T <sub>A</sub> = 70 °C		4.7 <sup>b, c</sup>	A		
Pulsed Drain Current		I <sub>DM</sub>	20			
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		9 <sup>a</sup>			
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.1 <sup>b, c</sup>			
	T <sub>C</sub> = 25 °C		13			
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	8.4	w		
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C		2.5 <sup>b, c</sup>			
	T <sub>A</sub> = 70 °C	1 [	1.6 <sup>b, c</sup>			
Operating Junction and Storage Temperatur	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			
Soldering Recommendations (Peak Temperations	ature) <sup>d, e</sup>		260			

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient <sup>b, f</sup>	o-Ambient <sup>b, f</sup> $t \le 5$ s $R_{thJA}$ 41 51		°C/W						
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	7.5	9.5	0/11				

Notes:

a. Package limited,  $T_C = 25$  °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

THE PRODUCTS DESCRIBED HEREIN AND THIS DOCI Downloaded From Oneyac.com

f. Maximum under steady state conditions is 105 °C/W.

### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			31		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 2.7		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.4		1	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA
Zara Cata Valtaga Drain Current	la e e	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	10			А
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.8 \text{ A}$		0.034	0.042	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 3.6 \text{ A}$		0.038	0.046	Ω
		$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 2 \text{ A}$		0.041	0.052	1
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 3.8 A		30		S
Dynamic <sup>b</sup>	•					•
Input Capacitance	C <sub>iss</sub>			560		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz		60		
Reverse Transfer Capacitance	C <sub>rss</sub>			27		
Tatal Cata Charge	0	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 8 \text{ V}, \text{ I}_{D} = 3.4 \text{ A}$		10	15	nC
Total Gate Charge	Qg			5.7	8.6	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 3.4 A		0.85		
Gate-Drain Charge	Q <sub>gd</sub>			0.75		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.6	3	6	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			6	12	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 4.3 $\Omega$		10	20	- - ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 3.5 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		20	40	
Fall Time	t <sub>f</sub>			10	20	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 4.3 $\Omega$		10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 3.5 A, $\text{V}_\text{GEN}$ = 8 V, $\text{R}_\text{g}$ = 1 $\Omega$		17	30	
Fall Time	t <sub>f</sub>			10	20	
Drain-Source Body Diode Characteristic	s			•		•
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			1.5	۸
Pulse Diode Forward Current	I <sub>SM</sub>				20	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3.5 A, V <sub>GS</sub> = 0 V		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			15	30	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			6	12	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 3.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		8		
Reverse Recovery Rise Time	t <sub>b</sub>			7		ns

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

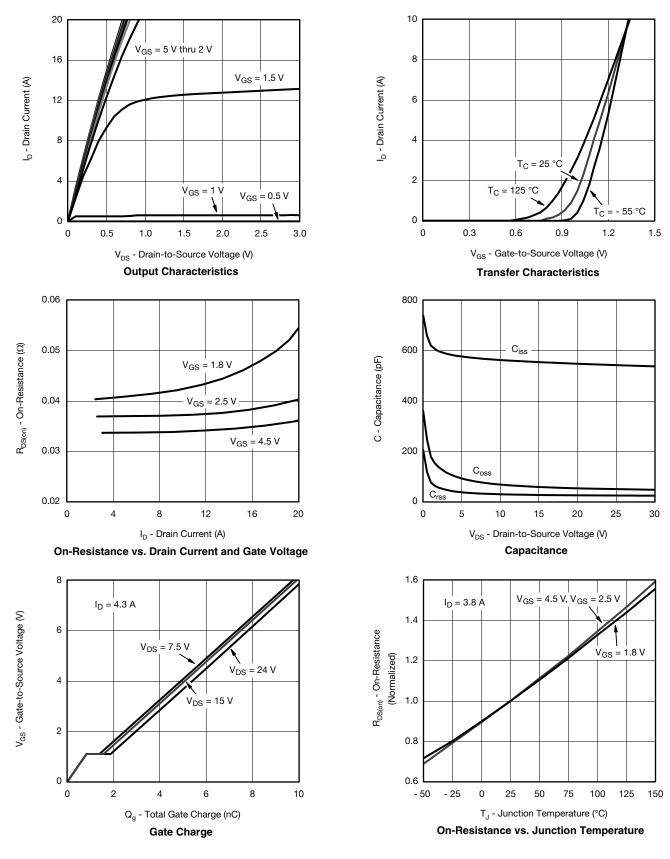
Document Number: 67020 S13-0630-Rev. B, 25-Mar-13

This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUV Downloaded From Oneyac.com -AIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



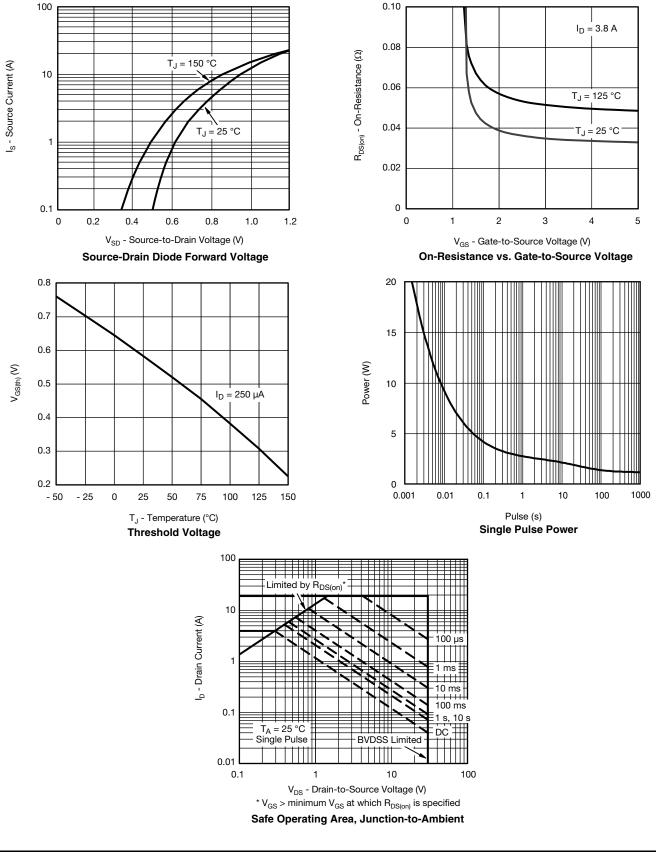
Document Number: 67020 For technical questions, contact: pmostechsupport@vishay.com S13-0630-Rev. B, 25-Mar-13

3

### Vishay Siliconix



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

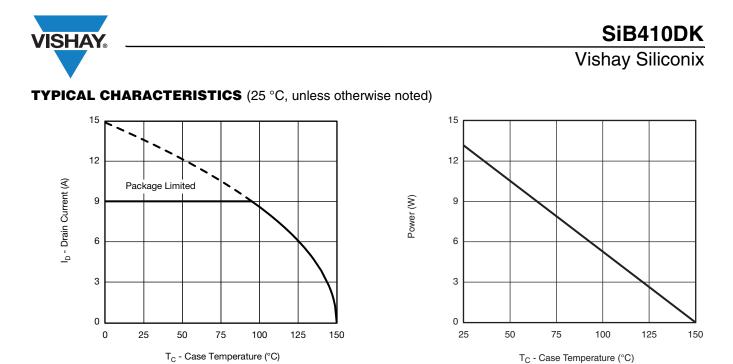


For technical questions, contact: pmostechsupport@vishay.com

Document Number: 67020 S13-0630-Rev. B, 25-Mar-13

4 This document is subject to chance without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUN Downloaded From Oneyac.com -AIMERS, S

AIMERS, SET FORTH AT www.vishay.com/doc?91000



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

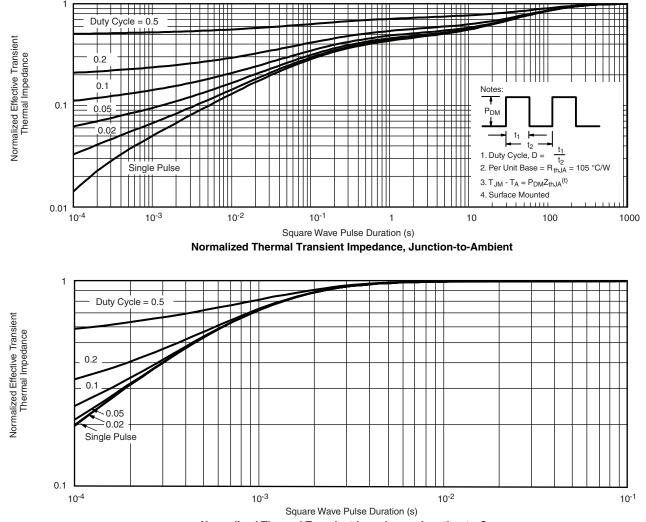
**Current Derating\*** 

**Power Derating** 

### Vishay Siliconix



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

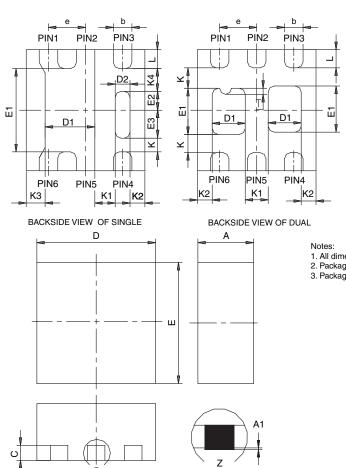
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?67020">www.vishay.com/ppg?67020</a>.

# Package Information

## Vishay Siliconix



PowerPAK<sup>®</sup> SC75-6L



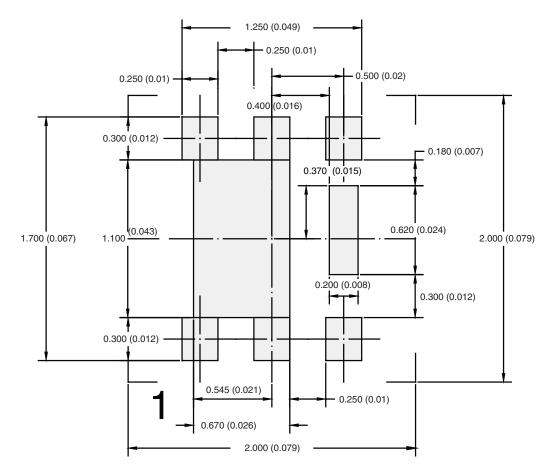
All dimensions are in millimeters
Package outline exclusive of mold flash and metal burr
Package outline inclusive of plating

DETAIL Z

	SINGLE PAD						DUAL PAD					
DIM	М	ILLIMETER	RS		INCHES		М	MILLIMETERS			INCHES	
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.18	0.25	0.33	0.007	0.010	0.013	0.18	0.25	0.33	0.007	0.010	0.013
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
D1	0.57	0.67	0.77	0.022	0.026	0.030	0.34	0.44	0.54	0.013	0.017	0.021
D2	0.10	0.20	0.30	0.004	0.008	0.012						
E	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
E1	1.00	1.10	1.20	0.039	0.043	0.047	0.51	0.61	0.71	0.020	0.024	0.028
E2	0.20	0.25	0.30	0.008	0.010	0.012						
E3	0.32	0.37	0.42	0.013	0.015	0.017						
е		0.50 BSC			0.020 BSC		0.50 BSC			0.020 BSC		
K		0.180 TYP			0.007 TYP		0.245 TYP			0.010 TYP		
K1		0.275 TYP			0.011 TYP		0.320 TYP			0.013 TYP		
K2		0.200 TYP			0.008 TYP		0.200 BSC			0.008 TYP		
K3	0.255 TYP 0.010 TYP											
K4	0.300 TYP			0.012 TYP								
L	0.15	0.25	0.35	0.006	0.010	0.014	0.15	0.25	0.35	0.006	0.010	0.014
Т							0.03	0.08	0.13	0.001	0.003	0.005
ECN: C-07431 – Rev. C, 06-Aug-07 DWG: 5935												



### RECOMMENDED PAD LAYOUT FOR PowerPAK<sup>®</sup> SC75-6L Single



Dimensions in mm/(Inches)

Return to Index



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.



单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)

>>点击查看相关商品